公TDK

June 2020



Chip varistors

Voltage Protection Devices

Automotive grade



AVRM, AVR-M series	
AVRM1608/AVR-M1608	JIS 1608 [EIA 0603]
AVRM2012/AVR-M2012	JIS 2012 [EIA 0805]
AVRL series	
AVRL10	JIS 1005 [EIA 0402]
AVRL16	JIS 1608 [EIA 0603]
AVRH series	
AVRH10	JIS 1005 [EIA 0402]

Product compatible with RoHS directive Compatible with lead-free solders AEC-Q200

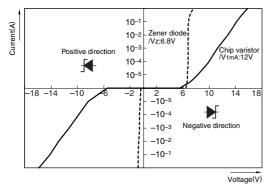
Overview of the AVR series

CHARACTERISTICS OF CHIP VARISTOR

Varistors are voltage dependent nonlinear resistive elements with a resistance that decreases rapidly when the voltage is over the constant value.

Varistors become zener diode of 2 serial connection and equivalent, and does not have polarity.

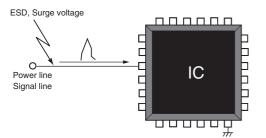
CURRENT vs. VOLTAGE CHARACTERISTICS



THE EFFECT OF THE VARISTOR

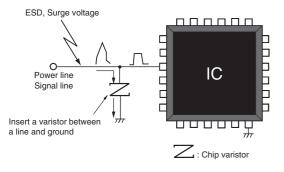
Without varistor

A malfunction and failure of electronic equipment



With Varistor

Suppress transient voltage by inserting varistor in a circuit



■ EQUIVALENT CIRCUIT OF CHIP VARISTORS



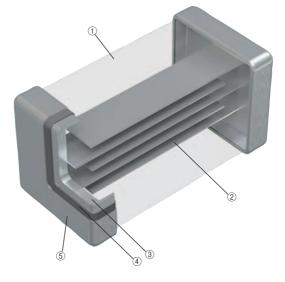
A capacitance content

CHIP VARISTORS FEATURE FOR AUTOMOTIVE

GRADE

- Reliability characteristics evaluated based on AEC-Q200 condition.
- O High ESD withstanding voltage
- Small-sized products are available
- 125°C, 150°C Supported

Figure 1 internal structure of multilayer chip varistors



No.	Name						
(1)	Semiconductor ceran	Semiconductor ceramic					
(2)	Internal electrode(Pd))					
(3)		Ag					
(4)	Terminal electrode	Ni					
(5)		Sn					

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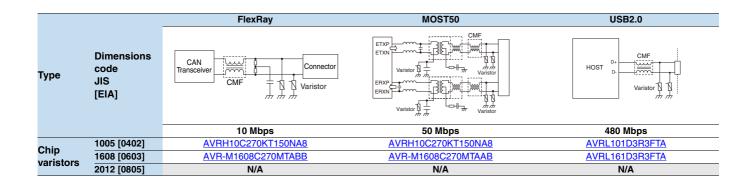
Product compatible with RoHS directive Compatible with lead-free solders AEC-Q200

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Overview of the AVR series

COMMUNICATION STANDARD, CIRCUIT EXAMPLE AND COMMUNICATION STANDARD

		LIN/CXPI	Classical CAN	CAN/CAN-FD
Туре	Dimensions code JIS [EIA]	LIN/CXPI Transceiver	CAN Transceiver Connector CMF N Varistor	CAN Transceiver
		20 kbps	1 Mbps	2-8 Mbps
Chin	1005 [0402]	N/A	AVRH10C270KT150NA8	AVRH10C270KT150NA8
Chip varistors	1608 [0603]	AVRM1608C270KT221M	AVR-M1608C270MTAAB	AVR-M1608C270MTABB
varistors	2012 [0805]	N/A	N/A	N/A



		One-Pair Ethernet 100BASE-T1	One-Pair Ethernet 1000BASE-T1	Motors
Туре	Dimensions code JIS [EIA]	100BASE-T1 PHY Varistor	1000BASE-T1 PHY Varistor	•Varistor(ESD)
		100Mbps	1000Mbps	-
Chip	1005 [0402]	AVRH10C101KT4R7FA8	AVRH10C101KT1R1NE8 AVRH10C221KT1R5YA8	N/A
varistors	1608 [0603]	N/A	N/A	AVR-M1608C270KT6AB
	2012 [0805]	N/A	N/A	AVR-M2012C390KT6AB

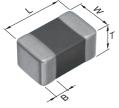
Automotive grade

Product compatible with RoHS directive Compatible with lead-free solders AEC-Q200

Overview of the AVR series

PART NUMBER CONSTRUCTION

AVRM	160)8		С	(390		K		Т			271		Ν	1
Series name	L x V dimens (mn	sions	Struct	ure code	Varist	tor voltage (V)		ristor voltage tolerance (%)		ckaging	style	interr	citance nal speci ymbol (pF)		apac tolera (%	
AVRM series	_	.6×0.8	C	General structure	390)=39×10 ⁰	- <u>-</u> к	±10	т	Тарі	ing	271	=27×10 ¹		к	±10
	2012 2	.0×1.2			220	22	M	±20	В	Bu	lk	221	220		М	±20
					270 390	27 39	N	±30	_	•		271	270		N	±30
AVR-M	160)8		C		270		М		т		A	AB			
Series name	L x dimens (mr	sions	Struct	ure code	Varist	tor voltage (V)	2	ristor voltage tolerance (%)		ckaging	style		ompany ial symb	ol		
AVR-M series	1608 1	.6×0.8	(:	General structure	270)=27×10 ⁰	ĸ	±10	т	Тарі	ing					
	2012 2	.0×1.2			220	22	M	±20	В	Bu	lk	_				
					270 390	27 39	N	±30	_							
AVRL	10)		1A		3R	3	F			Т		ŀ	٩		
AVRL Series name	L x V dimens (mr	W sions		1A Maximum nuous volta (Vdc)	age	Capacit	ance	Capacit tolera (pF	nce	Pack		g style	¢ Com special	pany		
Series name AVRL series	Lx dimens (mn 10 1	W sions n) .0×0.5		Maximum nuous volta	age	Capacit (pF 3R3	ance) 3.3	Capacit tolera (pF	n ce) ±1	Т	aging Tap	bing	Com	pany		
Series name	Lx dimens (mn 10 1	W sions n)	contii	Maximum nuous volta (Vdc)	age	Capacit (pF 3R3	ance)	Capacit tolera (pF	nce)		aging Tap		Com	pany		
Series name AVRL series	Lx dimens (mn 10 1	W sions n) .0×0.5 .6×0.8	contii	Maximum nuous volta (Vdc)		Capacit (pF 3R3	ance) 3.3	Capacit tolera (pF	nce) ±1 ±2	Т	aging Tap	bing	Com special	pany		8
Series name AVRL series L=Low cap AVRH	L x V dimensions	W sions n) .0x0.5 .6x0.8	1A	Maximum nuous volt: (Vdc) 10 270 Varistor voltage		Capacit (pF 3R3 6R8 K Varistor voltage tolerance	ance) 3.3 6.8	Capacit tolerat (pF G	nce) ±1 ±2 1! Capac	50	aging Tap Bu	bing ulk	Com special	pany symbol oltage ount 000-4-2	Ope temp	erating eratu imit
Series name AVRL series L=Low cap AVRH	L x V dimens (mm 10 1 16 1 10 L x W dimensions (mm)	W sions n) .0x0.5 .6x0.8 (Struc co	contin 1A C C C C C C C C C C C C C C C C C C	Maximum nuous volt: (Vdc) 10 270 Varisto	r t	Capacit (pF 3R3 6R8 K Varistor voltage	ance) 3.3 6.8	Capacit tolera (pF G T	nce) ±1 ±2 1 { Capac	<u> </u>	aging Tap Bu	ning ulk N pacitance	Com special 	pany symbol oltage ount 000-4-2	Ope temp	eratin
Series name AVRL series L=Low cap AVRH Series name	L x V dimensions	W sions n) .0x0.5 .6x0.8 (Struc co	contin 1A C C C C C C C C C C C C C C C C C C	Maximum nuous volt: (Vdc) 10 270 Varistor voltage (V)	r ; 0 ⁰ H	Capacit (pF 3R3 6R8 K Varistor voltage tolerance (%)	ance 3.3 6.8 Pack	Capacit tolera (pF G T	nce) ±1 ±2 1 { Capac	50 Sitance	aging Tap Bu	bing ulk N bacitance lerance	Com special ESD v amc IEC610 (k	pany symbol oltage punt 000-4-2 V)	Ope temp I	eratin eratu imit (°C)



Shape symbol(JIS)	L	W	т	В
1005	1.00±0.05	0.50±0.05	0.50±0.05	0.1min.
1608	1.60±0.1	0.80±0.1	0.80±0.1	0.2min.
2012	2.00±0.2	1.25±0.2	1.00±0.2	0.2min.

A Please be sure to request delivery specifications that provide further details on the features and specifications of the products for proper and safe use. Please note that the contents may change without any prior notice due to reasons such as upgrading.

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Automotive grade

Product compatible with RoHS directive Compatible with lead-free solders AEC-Q200

Overview of the AVR series

OPERATING TEMPERATURE RANGE, PACKAGE QUANTITY, PRODUCT WEIGHT

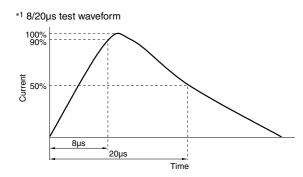
	Temperat	ure range	Package quantity	Individual weight
Туре	Operating temperature* (°C)	Storage temperature** (°C)	(pieces/reel)	(mg)
AVRM1005 AVR-M1005 AVRL10	-40 to +125	-40 to +125	10,000	1.2
AVRH10	-55 to +150	-55 to +150		
AVRM1608 AVRL16 AVR-M1608	-40 to +125	-40 to +125	4,000	5
AVR-M2012			2,000	13

* Operating temperature range includes self-temperature rise.

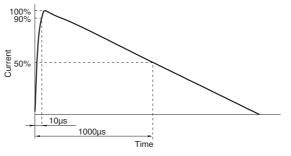
** The storage temperature range is for after the assembly.

TERMINOLOGY

Item	Unit	Description
Varistor voltage	V1mA	Chip varistor-terminal voltage when DC1mA was flowed
(Breakdown voltage)	(V)	Chip various terminal volage when Do min was nowed
	Vdc	DC voltage that is continuously applied between chip varistor terminals
Maximum continuous voltage	(V)	Terminal chip varistors leakage current-value: 50µA max
	(v)	Voltage appearing across the varistor when a pulse current (8/20µs*1) of specified peak value is applied.
Clamping voltage	Vcl	Voltage between terminal chip varistors of the Specified peak current value of the impulse current(8/
Clamping voltage	(V)	20μs*1) is applied
Movimum operav	E	When applied specified peak impulse current-value current(10/1000µs*2) once, maximum energy that
Maximum energy	(Joule)	electrical property of chip varistors be not deteriorated
Movimum pools ourront	lp	When applied impulse current(8/20µs*1) once, maximum current that electrical property of chip varistors
Maximum peak current	(A)	be not deteriorated
Canacitanaa	С	Oscillator frequency 1kHz or 1MHz, Capacitance between chip varistor-terminal in oscillator voltage
Capacitance	(pF)	1Vrms



*2 10/1000µs test waveform



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Automotive grade

AVR series (Automotive grade) Product characteristics list

PRODUCT CHARACTERISTICS LIST

Item	Size	V (1mA)	C1kHz *C1MHz	Vdc	Clamping voltage 8/20µs Pulse	Maximum energy 10/1000µs Pulse	Maximum peak current 8/20µs Pulse	IEC61000-4-2 (Contact)	AEC- Q200
	(mm)	(V)	(pF)	DC (V)	Vcl (V)		lp (A)	150pF/330 Ω	
AVRL101D3R3FTA	1.0 x 0.5 (EIA0402)	27(21.6 to 32.4)	3.3(2.3 to 4.3)*	20	62(0.5A)	0.01	0.5	8kV	~
AVRL101D6R8GTA	1.0 x 0.5 (EIA0402)	27(21.6 to 32.4)	6.8(4.8 to 8.8)*	20	58(1A)	0.01	1	8kV	v
AVRH10C270KT150NA8	1.0 x 0.5 (EIA0402)	27(24.0 to 30.0)	15(10.5 to 19.5)	19	52(2A)	0.02	2	25kV	~
AVRH10C270KT350NA8	1.0 x 0.5 (EIA0402)	27(24.0 to 30.0)	35(24.5 to 45.5)	19	52(2A)	0.02	8	25kV	v
AVRH10C390KT500NA8	1.0 x 0.5 (EIA0402)	39(35.0 to 43.0)	50(35 to 65)	28	72(2A)	0.02	15	25kV	~
AVRH10C101KT4R7FA8	1.0 x 0.5 (EIA0402)	100(90 to 110)	4.7(3.7 to 5.7)*	70	190(1A)	0.03	1	25kV	v
AVRH10C101KT1R1NE8	1.0 x 0.5 (EIA0402)	110(100 to 120)	1.1(0.8 to 1.4)*	70	190 (0.3A)	0.01	0.3	8kV	~
AVRH10C221KT1R5YA8	1.0 x 0.5 (EIA0402)	220 (198 to 242)	1.5(1.37 to 1.63)*	70	400 (0.5A)	0.01	0.5	25kV	
AVRL161D3R3FTA	1.6 x 0.8 (EIA0603)	27(21.6 to 32.4)	3.3(2.3 to 4.3)*	20	62(0.5A)	0.01	0.5	8kV	~
AVRL161D6R8GTA	1.6 x 0.8 (EIA0603)	27(21.6 to 32.4)	6.8(4.8 to 8.8)*	20	58(1A)	0.01	1	8kV	v
AVR-M1608C220KT2AB	1.6 x 0.8 (EIA0603)	22(19.8 to 24.2)	210(147 to 273)	16	37(2A)	0.03	10	25kV	~
AVR-M1608C220KT6AB	1.6 x 0.8 (EIA0603)	22(19.8 to 24.2)	560(392 to 728)	16	34(2A)	0.10	30	25kV	v
AVR-M1608C270MTABB	1.6 x 0.8 (EIA0603)	27(21.6 to 32.4)	15(10.5 to 19.5)	17	52(2A)	0.05	2	25kV	~
AVR-M1608C270MTAAB	1.6 x 0.8 (EIA0603)	27(21.6 to 32.4)	30(21 to 39)	17	52(2A)	0.05	2	25kV	v
AVR-M1608C270KTACB	1.6 x 0.8 (EIA0603)	27(24.0 to 30.0)	60(42 to 78)	19	54(2A)	0.05	10	25kV	~
AVRM1608C270KT800M	1.6 x 0.8 (EIA0603)	27(24.0 to 30.0)	80(64 to 96)	19	53(2A)	0.02	28	25kV	v
AVR-M1608C270KT2AB	1.6 x 0.8 (EIA0603)	27(24.0 to 30.0)	160(112 to 208)	19	42(2A)	0.10	20	25kV	~
AVRM1608C270KT221M	1.6 x 0.8 (EIA0603)	27(24.0 to 30.0)	220(176 to 264)	19	52(2A)	0.10	40	25kV	v
AVR-M1608C270KT6AB	1.6 x 0.8 (EIA0603)	27(24.0 to 30.0)	430(301 to 339)	19	42(2A)	0.10	48	25kV	~
AVRM1608C390KT271N	1.6 x 0.8 (EIA0603)	39(35.0 to 43.0)	270(189 to 351)	28	69(2A)	0.10	78	25kV	v
AVRM1608C560KT101M	1.6 x 0.8 (EIA0603)	56(50.4 to 61.6)	100(80 to 120)	40	113(2A)	0.10	60	25kV	~
AVRM1608C720KT750M	1.6 x 0.8 (EIA0603)	72(64.8 to 79.2)	75(60 to 90)	53	135(2A)	0.10	40	25kV	v
AVR-M2012C220KT6AB	2.0 x 1.2 (EIA0805)	22(19.8 to 24.2)	800(560 to 1040)	16	38(5A)	0.30	100	25kV	~
AVRM2012C330KT801N	2.0 x 1.2 (EIA0805)	33(29.7 to 36.3)	800(560 to 1040)	24	59(5A)	0.50	240	25kV	v
AVR-M2012C390KT6AB	2.0 x 1.2 (EIA0805)	39(35.0 to 43.0)	430(301 to 559)	28	62(5A)	0.30	100	25kV	~
AVRM2012C560KT251M	2.0 x 1.2 (EIA0805)	56(50.4 to 61.6)	250(200 to 300)	40	113(5A)	0.30	150	25kV	v
AVRM2012C720KT201M	2.0 x 1.2 (EIA0805)	72(64.8 to 79.2)	200(160 to 240)	53	142(5A)	0.30	100	25kV	v

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Product compatible with RoHS directive Compatible with lead-free solders AEC-Q200

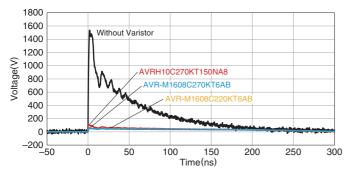
Product compatible with RoHS directive Compatible with lead-free solders AEC-Q200

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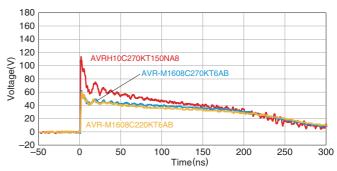
AVR series Electrostatic absorption characteristics

DISCHARGE VOLTAGE WAVEFORM (EXAMPLE)

□ WITHOUT VARISTOR, WAVEFORM AT VARISTOR INSTALLATION

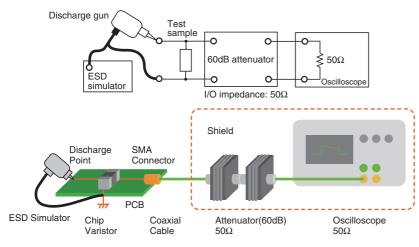


WAVEFORM AT VARISTOR INSTALLATION



Test conditions
150pF/330Ω (IEC61000-4-2)
Contact discharge, Charged voltage 8kV

TEST CIRCUIT DIAGRAM



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Product compatible with RoHS directive Compatible with lead-free solders AEC-Q200

+25kV/-25kV

1000

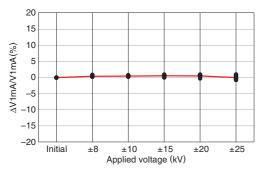
+25kV/-25kV

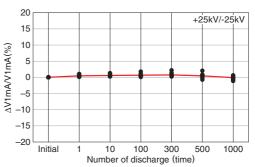
Automotive grade

AVR series Electrostatic discharge tests

APPLIED VOLTAGE STEP(VOLTAGE 10TIMES APPLIED)

□AVRH10C270KT150NA8 (Voltage % change at reference current: within ±10%)





20

15

10

0

-5

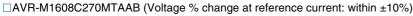
-10

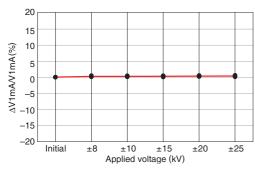
-15

-20 Initial

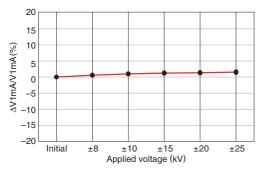
20

ΔV1mAV1mA(%) 5

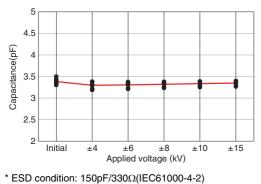




□AVR-M2012C390KT6AB (Voltage % change at reference current: within ±10%)



□AVRL101D3R3FTA(Capacitance: 5pF or less)



15 10 ΔV1mA/V1mA(%) 5 0 -5 -10 -15 -20 Initial 10 100 300 500 1000 Number of discharge (time) 5 +8kV/-8kV 4.5 4

10

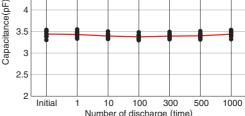
1

100

Number of discharge (time)

300

500



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■ REPEATED VOLTAGE APPLICATION(~1000 times)

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Product compatible with RoHS directive Compatible with lead-free solders AEC-Q200

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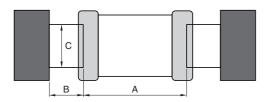
Attention on a circuit board design

Board design

When attached to chip varistors, amount of silver used (fillet size) has direct impact on chip varistors after mounting. Thus, sufficient consideration is necessary.

Set of land dimensions

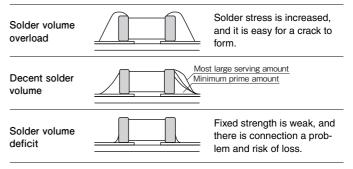
(1) As the stress rises in the chip varistors owing to the increase in silver, breakage and cracks will occur. Cause including crack, as caution on board land design, configure the shape and dimensions so that the amount of silver is appropriate. If you installed 2 or more parts in the Common Land, separated by a solder resist and special land of each component.



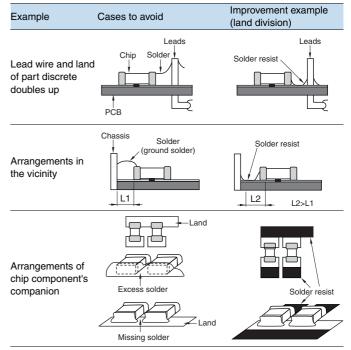
Dimensions shape	Symbol		
Dimensions shape	A	В	С
1005	0.30 to 0.50	0.35 to 0.45	0.40 to 0.60
1608	0.60 to 0.80	0.60 to 0.80	0.60 to 0.80
2012	0.90 to 1.20	0.70 to 0.90	0.90 to 1.20

(2) When peak levels panning-at soldering is excessive, by solder contraction stress, mechanical-thermal stress causes a Yasuku chip crack. In addition, when the peak level is underestimated, terminal electrode fixed strength is insufficient. This causes chip dropouts and may affect circuit reliability. Representative example of the panning of peak levels is shown in the following.

Recommended silver dose



Case and suggested protocol want to avoid



Product compatible with RoHS directive Compatible with lead-free solders AEC-Q200

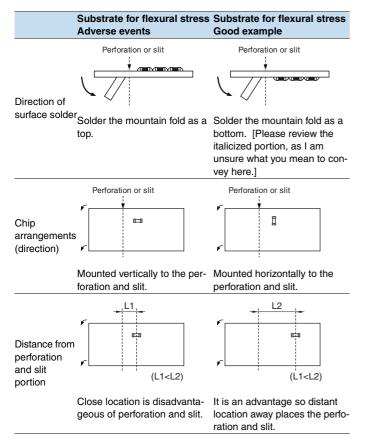
(10/14)

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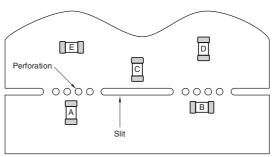
Attention on a circuit board design

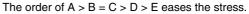
Arrangements of components

(1) I was based on camber of substrate and suggested protocol of chip varistors arrangement, as stress does not join to the utmost is shown in following.



(2) In payment near by board, depending on mount position of chip varistors, as mechanical stress varies, please refer to the following diagram.





Product compatible with RoHS directive Compatible with lead-free solders AEC-Q200

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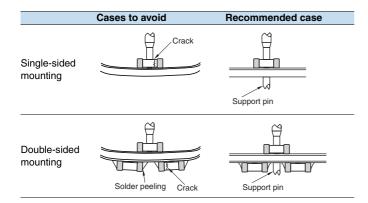
Local precautions

Application to board

Mounting head pressure

Under suction nozzle if dead point too, during implementation, excessive force joins of chip varistors low, as cause causes of crack, please use with reference to something about following.

- Being set to top surface of substrate so that under suction nozzle as for dead center, substrate does not bend back, and adjust, please.
- 2) Nozzle pressure at implementation is 0.1 to 0.3N in static load, please.
- Substrate fixes up back surface of substrate with support pin in impact of suction nozzle to wely deflection to the utmost, and substrate hold deflection, please. A representative example is shown in the following.



Mechanical shock that, if positioning your nail to wear, ragged edge of positionings, participates in chip varistors are locally, and chip varistors, as there is possibility of crack generated, cut the closed positioning, and maintenance and inspection, and, exchange of manage dimensions and position nail periodically, please.

Soldering

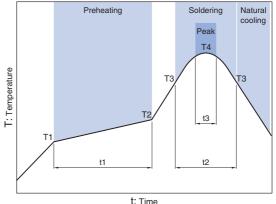
Significant impact is possible on the performance of chip varistors, flux checks something about follow, please use.

(1) Flux uses one with 0.1wt % (Cl conversion) or less halide substance contains amounts, please. In addition, do not do this with strongly acidic objects.

Flux during is soldered (2) Chip varistors is applied the smalleset amount necessary, please.

(3) If Used soluble flux, perform thorough wash particularly, please.

Reflow temperature profile



	Specification					
Item	For eutectic mixture	Use of lead-free				
	solder	solder				
Preheating temperature	160 to 180°C	150 to 180°C				
Solder melting temperature	200°C	230°C				
Maximum temperature	240°C max.	260°C max.				
Preheating time	100s max.	120s max.				
Time to reach higher than the solder melting temperature	30s max.	40s max.				
number of possible reflow cycles	2 max.	2 max.				

Soldering iron

The tip temperature and also by (1) types of soldering irons, the size of the substrate, and the geometry of the land pattern. Being earlier, but when as there is possibility that crack occurs in the heat anderson impaction, point soldering iron temperature is high, please do solder work within the following conditions.

Temperature of iron tips (°C)	Wattage (W)	Pallet point shape (mm)	Soldering time (Second)	Frequency
350max.	30max.	ø3.0max.	5 max.	Within each terminal once (Within total of twice)

Direct iron tip is in contact with the (2) chip varistors body, and the strain owing to thermal shock in particular grows even if a crack is generated. Therefore, please do not touch it directly to the terminal electrodes.

Voltage Protection Devices

Chip varistors Automotive grade

Product compatible with RoHS directive Compatible with lead-free solders AEC-Q200

Attention after implementation

Cleaning

(1) If cleaning liquid is inappropriate, residues and other foreign body of fluxes builds up on chip varistors, and can degrade the performance of chip varistors (particularly the insulation resistance).(2) Wash conditions may compromise performance of chip varistors if they are improper (wash due, wash excess).

2-1) For wash due

- (a) By substance of a system in flux residue halide, metal including terminal electrodes may experience corrosion.
- (b) Substance of a system in flux residue halide builds up on chip varistors, and reduces the insulation resistance.
- (c) Soluble flux makes comparisons of colophony series flux, and there is event with trends of significant (1) and(2).

2-2) For excess wash

- (1) Owing to lavage, chip varistors deteriorates, and reduces performance of chip varistors.
- (2) In ultrasonography, when output is passed, substrate resonates size, and crack occurs in body and sprang of chip varistors in vibration of substrate. Since this may reduce the strength of the terminal electrode, please note the following conditions. [Please review the italicized portion, as I am unsure what you mean to convey here.]

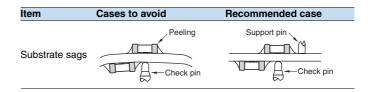
Ultrasound output Ultrasonic frequency Ultrasound cleaning time

2-3) Concentration including halogen that when cleaning liquid to pollution, when you released is higher, and may cause similar of results into wash due.

Substrate handling after component mounting

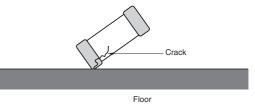
(1) When substrate is divided, a flexible so that show in following diagram to substrate, and is given by stress including twist, as there is possibility that crack occurs of chip varistors, please check that stress is within acceptable limits.

Bends Twist (2) During each substrate operational check, push pressure with contact failure of check pin of boards checkers of check pin may be toned up to be prevented. As substrate is bent under loading, chip varistors is broken owing to stress. There is also the possibility that solder on the terminal electrode will peel off. Follow the diagram for reference, and check that the substrate bends, please.

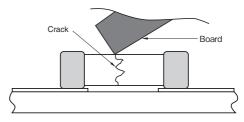


Single-part component handling

To drop impact, as there is possibility that breakage and crack is entered, do not chip varistors that(1) chip varistors falls.



(2) At stacking storage after implementation and treatment of substrate, corner of boards is regarded as chip varistors. Please be careful, as there is the possibility that breakage and cracks will occur on impact.



(12/14)

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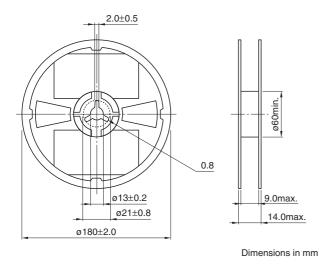
Chip varistors

Automotive grade

Product compatible with RoHS directive Compatible with lead-free solders AEC-Q200

Packaging style

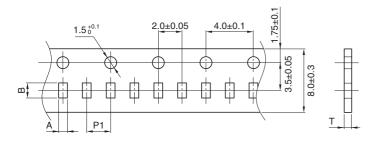
REEL DIMENSIONS



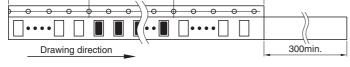
PACKAGE QUANTITY / INDIVIDUAL WEIGHT

Tuno	Package quantity	Individual weight	
Туре	(pieces/reel)	(mg)	
1005	10,000	1.3	
1608	4,000	5.3	
2012	2,000	13.0	

TAPE DIMENSIONS



	Dimensions in mm					
Туре	A	В	P1	Т		
1005	0.65+0.05/-0.1	1.15+0.05/-0.1	2±0.05	0.65max.		
1608	1.1±0.2	1.9±0.2	4±0.1	1.1max.		
2012	1.6±0.2	2.3±0.2	4±0.1	1.7max.		
160min.	Taping	200min.				



Dimensions in mm

REMINDERS FOR USING THESE PRODUCTS

Before using these products, be sure to request the delivery specifications.

SAFETY REMINDERS

Please pay sufficient attention to the warnings for safe designing when using this products.

▲ REMINDERS Please pay careful attention to the precautions and follow safe designing practices when using these products. O Please observe the following precautions in order to avoid problems with chip varistors such as characteristic degradation and element destruction Please store these products in an environment with a temperature of 5 to 40°C and humidity level of 20 to 70%RH, and use them within six months Poor storage conditions may lead to the deterioration of the solderability of the edge electrodes, so please be careful to avoid contact with humidity, dew condensation, dust, toxic gas (hydrogen, hydrogen sulfide, sulfurous acid, chlorine, ammonia, etc.), direct sunlight, and so on. Please do not use products that have been dropped or detached when mounting. Please solder with the reflow soldering method, and not the flow (dip) soldering method. O Please observe the following precautions to avoid problems with varistors such as characteristic degradation and element destruction. which ultimately lead to the generation of heat and smoke with the elements. Do not use in locations where the temperatures exceed the operating temperature range such as under direct sunlight or near sources of heat. Do not use in locations where there are high levels of humidity such as under direct exposure to weather and areas where steam is released. Do not use in locations such as dusty areas, high-saline environments, places where the atmosphere is contaminated with corrosive gas, etc. Avoid powerful vibrations, impact (such as by dropping), pressure, etc. that may lead to splitting in the products. Do not use with a voltage that exceeds the maximum allowable circuit voltage. When resin coating (including modular) a varistor, do not use a resin that will cause deterioration of the varistor. Be sure never to use resin that generates hydrogen as palladium is used for the inner electrode. Avoid attachment near combustible materials. O Please contact our sales offices when considering the use of the products listed on this catalog for applications, whose performance and/or quality require a more stringent level of safety or reliability, or whose failure, malfunction or trouble could cause serious damage to society, person or property ('specific uses' such as automobiles, airplanes, medical instruments, nuclear devices, etc.) as well as when considering the use for applications that exceed the range and conditions of this catalog. Please also contact us when using these products for automotive applications. O As range of catalog, conditions are transcended, or for damage that generated by was used in application specific, etc, accept no the responsibility, wish. O Please take appropriate measures such as acquiring protective circuits and devices that meet the uses, applications, and conditions of the instruments and keeping backup circuits.